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	Application No.	Applicant(s)	an
Mada All 1996 .	10/765,699	KATZ, ZACHARY B.	
Notice of Allowability	Examiner	Art Unit	
	Thao P. Le	2818	
The MAILING DATE of this communication app All claims being allowable, PROSECUTION ON THE MERITS Is herewith (or previously mailed), a Notice of Allowance (PTOL-8: NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT of the Office or upon petition by the applicant. See 37 CFR 1.3	S (OR REMAINS) CLOSED i 5) or other appropriate comm RIGHTS. This application is	n this application. If not included nunication will be mailed in due could be mailed in due could be applied by the could be a	rse. THIS
1. This communication is responsive to <u>01/26/04</u> .			
2. X The allowed claim(s) is/are <u>1-39</u> .			
3. $igotimes$ The drawings filed on <u>26 January 2004</u> are accepted by	the Examiner.		
4. Acknowledgment is made of a claim for foreign priority a) All b) Some* c) None of the: 1. Certified copies of the priority documents ha 2. Certified copies of the priority documents ha 3. Copies of the certified copies of the priority of International Bureau (PCT Rule 17.2(a)). * Certified copies not received:	ve been received. ve been received in Applicati	on No	from the
Applicant has THREE MONTHS FROM THE "MAILING DATE noted below. Failure to timely comply will result in ABANDON THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.		e a reply complying with the require	ements
 A SUBSTITUTE OATH OR DECLARATION must be sub INFORMAL PATENT APPLICATION (PTO-152) which g 	omitted. Note the attached EX ives reason(s) why the oath o	AMINER'S AMENDMENT or NOTI or declaration is deficient.	CE OF
6. CORRECTED DRAWINGS (as "replacement sheets") m (a) including changes required by the Notice of Draftspecture. 1) hereto or 2) to Paper No./Mail Date (b) including changes required by the attached Examined Paper No./Mail Date Identifying indicia such as the application number (see 37 CFR each sheet. Replacement sheet(s) should be labeled as such in	erson's Patent Drawing Revie er's Amendment / Comment o	or in the Office action of the drawings in the front (not the bac	ck) of
 DEPOSIT OF and/or INFORMATION about the department department regarding REQUIREMEN 			e the
Attachment(s) 1. ☑ Notice of References Cited (PTO-892) 2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948) 3. ☑ Information Disclosure Statements (PTO-1449 or PTO/SE Paper No./Mail Date 2 pages 4. ☐ Examiner's Comment Regarding Requirement for Deposi of Biological Material	8) 6. Interview 9 Paper No 3/08), 7. Examiner	nformal Patent Application (PTO-18 Summary (PTO-413), ./Mail Date s Amendment/Comment s Statement of Reasons for Allowar	

DETAILED ACTION

Claims 1-39 are pending.

Information Disclosure Statement

The information disclosure statement (IDS) submitted on 01/26/04 was filed on the same mailing date of the application. The submission is in compliance with the provisions of 37 CFR 1.97. Accordingly, the information disclosure statement is being considered by the examiner.

Reason for allowance

Claims 1-39 are allowed. The following is an examiner's statement of reason for allowance:

Set of claims 1-14: None of the references of record teaches or suggests the claimed limitations having a method of forming a planarized surface over a semiconductor substrate comprising a non-planar surface topography substrate, forming a spin-on-dielectric layer over the substrate, forming a second dielectric over the spin-on-dielectric layer, and polishing the second dielectric layer and the spin-on-dielectric layer to form an electrically insulative surface comprising both the spin-on-dielectric material and the second dielectric material.

Set of claims 15-27: None of the references of record teaches or suggests the claimed limitations having a method of forming a planarized surface over a semiconductor substrate comprising a memory array region which has a different average elevational height than the a peripheral region, forming a polysilazane layer

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over both regions, forming a second material over the polysilazane layer, planarizing the second material and the polysilazane layer to form a planarized surface comprising primarily the polysilazane over one of the memory array and peripheral regions and comprising primarily the second material over the other of the memory array and peripheral regions.

Set of claims 28-39: None of the references of record teaches or suggests the claimed limitations having a method of forming a planarized surface over a semiconductor substrate comprising a memory array region which has a different average elevational height than the a peripheral region, forming a spin-on-dielectric layer over both regions, forming a second material over the spin-on-dielectric layer, planarizing the second material and the spin-on-dielectric layer to form a planarized surface comprising primarily the spin-on-dielectric over one of the memory array and peripheral regions and comprising primarily the second material over the other of the memory array and peripheral regions.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance".

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Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thao P. Le whose telephone number is 571-272-1785. The examiner can normally be reached on M-T (7-6).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David Nelms can be reached on 571-272-1787. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Thao P. Le Art Unit 2818 January 19, 2006.